

SEMITOP[®]3

3-phase bridge rectifier + brake chopper + 3-phase bridge inverter SK 30 DGDL 066 ET

Target Data

Features

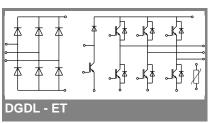
- Compact design
- One screw mounting
- · Heat transfer and isolation through direct copper bonded aluminium oxide ceramic (DCB)
- Trench IGBT technology
- CAL technology FWD
- Integrated NTC temperature sensor

Typical Applications*

- Inverter up to 10 kVA
- Typ. motor power 4 kW

Remarks

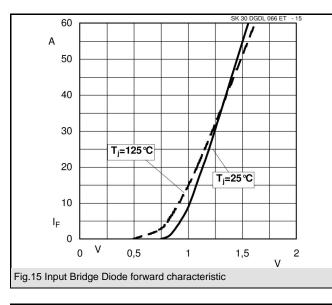
- V_{CE,sat}, V_F = chip level value
 SC data:
- $t_{p} \le 6\mu s; V_{GE} \le 15V; T_{j} = 150^{\circ}c; V_{cc} = 360^{\circ}V_{isol} = 3000V AC, 50Hz, 1s$

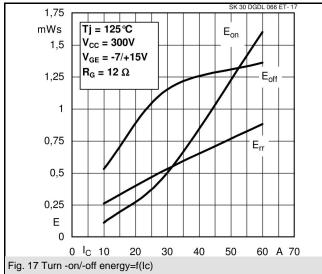


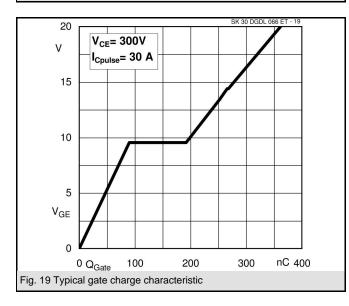
Absolute Maximum Ratings $T_s = 25^{\circ}C$, unless otherwise specified								
Symbol	Conditions	Values	Units					
IGBT - Inverter, chopper								
V _{CES}		600	V					
I _C	T _s = 25 (70) °C, T _j = 175 °C	40 (31)	А					
I _C	$T_s = 25 (70) °C, T_j = 150 °C$	35 (26)	A					
I _{CRM}	$I_{CRM} = 2 \times I_{Cnom}, t_p = 1 \text{ ms}$	60	А					
V _{GES}		± 20	V					
Т _ј		-40 + 175	°C					
Diode - Inverter, chopper								
I _F	T _s = 25 (70) °C, T _i = 150 °C	32 (24)	А					
I _F	T _s = 25 (70) °C, T _j = 175 °C	36 (28)	А					
I _{FRM}	$I_{FRM} = 2 \times I_{Fnom}, t_p = 1 \text{ ms}$	60	А					
Diode - Rectifier								
V _{RRM}		800	V					
I _F	T _s = 70 °C	35	А					
I _{FSM}	t _p = 10 ms, sin 180 °, T _j = 25 °C	370	А					
i²t	t _p = 10 ms, sin 180 °, T _j = 25 °C	680	A²s					
T _j		-40 + 175	°C					
T _{sol}	Terminals, 10 s	260	°C					
T _{stg}		-40 + 125	°C					
V _{isol}	AC, 1 min.	2500	V					

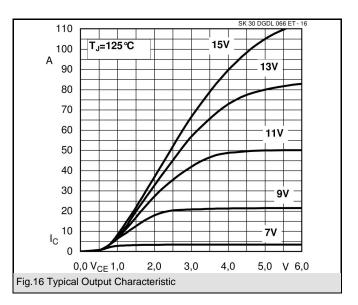
	Character	istics	$T_s = 25^{\circ}C$, unless otherwise specified						
	Symbol	Conditions	min.	typ.	max.	Units			
	IGBT - Inverter, chopper								
	V _{CE(sat)}	I _{Cnom} = 30 A, T _j = 25 (150) °C			1,85 (2,05)	V			
	V _{GE(th)}	$V_{GE} = V_{CE}, I_C = 0,43 \text{ mA}$	5	5,8	6,5	V			
	V _{CE(TO)}	$T_j = 25 (150) °C$		0,9 (0,85)	1 (0,9)	V			
60\	r _{CE}	$T_{j} = 25 (150) °C$		18 (27)	28 (38)	mΩ			
	C _{ies}	$V_{CE} = 25 V, V_{GE} = 0 V, f = 1 MHz$		1,63 0,11		nF nF			
	C _{oes}	V _{CE} = 25 V, V _{GE} = 0 V, f = 1 MHz V _{CE} = 25 V, V _{GE} = 0 V, f = 1 MHz		0,11		nF			
	C _{res}								
	R _{th(j-s)}	per IGBT		1,65		K/W			
	t _{d(on)}	under following conditions		15		ns			
	t _r	$V_{CC} = 300 \text{ V}, V_{GE} = -7/+15$		12		ns			
	t _{d(off)}	I _{Cnom} = 30 A, T _j = 125 °C		228 46		ns ns			
	t _f Γ (Γ)	$R_{Gon} = R_{Goff} = 12 \Omega$							
	E _{on} (E _{off})	inductive load		0,55 (1,15)		mJ			
		verter, chopper							
	N _F = V _{EC}	$I_F = 30 \text{ A}, T_j = 25 (150) ^{\circ}\text{C}$		1,5 (1,5)	1,7 (1,7)	V			
	V _(TO)	$T_j = 25 (150) \ ^{\circ}C$		1 (0,9)		V			
	r _T	T _j = 150 () °C		20		mΩ			
	R _{th(j-s)}	per diode		2,3		K/W			
	I _{RRM}	under following conditions		19,1		А			
	Q _{rr}	$I_{Fnom} = 30 \text{ A}, V_{R} = 300 \text{ V}$		1,8		μC			
	E _{rr}	V _{GE} = 0 V, T _j = 125°C		0,53		mJ			
		di _F /dt = -950 A/µs							
	Diode rectifier								
	V _F	I _{Fnom} = 25 A, T _j = 25 °C		1,1		V			
	V _(TO)	T _j = 150 °C		0,8		V			
٦	r _T	T _j = 150 °C		15		mΩ			
	R _{th(j-s)}	per diode		1,7		K/W			
	Temperature Sensor								
~	R _{ts}	5 %, T _r = 25 (100) °C		5000(493)		Ω			
1	Mechanical Data								
	w			30		g			
	M _s	Mounting torque	2,25		2,5	Nm			

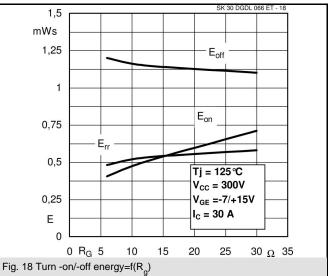
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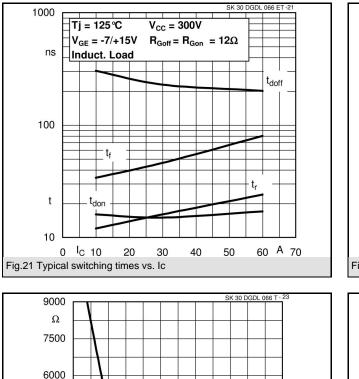


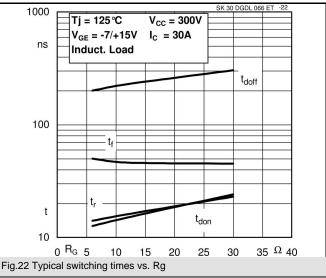


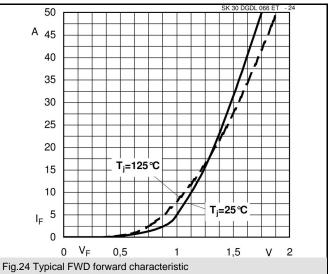












4500

3000

1500

0

 $0T_{\text{DBC}}$ 25

Fig.23 Typical NTC characteristic

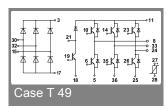
50

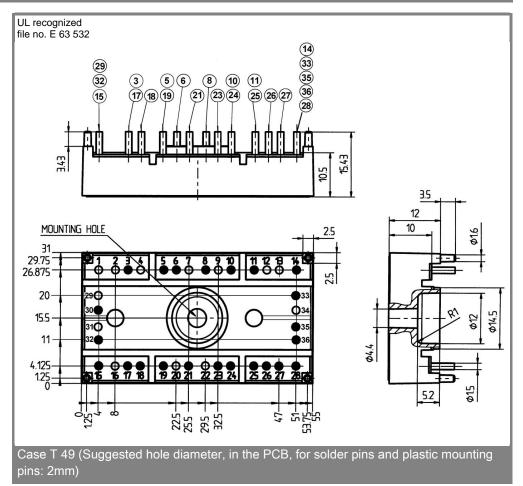
75

100

125 _℃ 150

R





This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our personal.